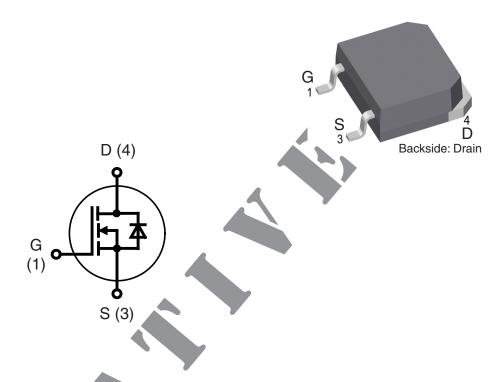


## SiC Power MOSFET

**I**<sub>D25</sub> 90 A = 1200 V $\mathbf{R}_{\mathrm{DS(on)\;max}}$  = 34 m $\Omega$ 

## Single MOSFET

Part number MCB60I1200TZ



### Features / Advantages:

- · High speed switching with low capacitances
- High blocking voltage with low R<sub>DS(on)</sub>
- · Easy to parallel and simple to drive
- Avalanche ruggedness
- Resistant to latch-up

## Applications:

- Solar inverters
- High voltage DC/DC converters
- Motor drives
- Switch mode power supplies
- •UPS
- Battery chargers
- Induction heating

Package: TO-268AA (D3Pak-HV)

- · Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0
- High creepage distance between terminals

Terms & Conditions of usage
The data contained in this product data sheet is e ely intended for technically trained staff. The user will have to evaluate the suitability of the product for the intended application and the completeness of the product The data contained in this product data sheet is exclusively intended for technically trained staff. The user will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to his application. The specifications of our components may not be considered as an assurance of component characteristics. The information in the valid application- and assembly notes must be considered. Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of your product, please contact the sales office, which is responsible for you. Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact the sales office, which is responsible for you. Should you intend to use the product in aviation, in health or live endangering or life support applications, please notify. For any such application we urgently recommend - to perform joint insk and quality assessments; - the conclusion of quality agreements; - to establish joint measures of an ongoing product survey, and that we may make delivery dependent on the realization of any such measures.

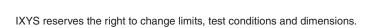
IXYS reserves the right to change limits, test conditions and dimensions.



MOSFET	SFET						
Symbol	Definitions	Conditions		min.	typ.	max.	
V <sub>DSS</sub>	drain source breakdown voltage					1200	V
V <sub>GSM</sub>	max transient gate source voltage continous gate source voltage	recommended operational value		-10 -5		+25 +20	V V
I <sub>D25</sub> I <sub>D80</sub> I <sub>D100</sub>	drain current		$T_{c} = 25^{\circ}C$ $T_{c} = 80^{\circ}C$ $T_{c} = 100^{\circ}C$			90 70 60	A A A
R <sub>DSon</sub>	static drain source on resistance	$I_D = 50 \text{ A}; V_{GS} = 20 \text{ V}$	$T_{VJ} = 25^{\circ}C$ $T_{VJ} = 150^{\circ}C$ $T_{VJ} = 175^{\circ}C$		25 43 52	34	mΩ mΩ mΩ
$V_{GS(th)}$	gate threshold voltage	$I_D = 15 \text{ mA}; V_{DS} = 10 \text{ V}$	$T_{VJ} = 25^{\circ}C$ $T_{VJ} = 175^{\circ}C$	2.0	2.6 2.1	4.0	V V
I <sub>DSS</sub>	drain source leakage current	$V_{DS} = 1200 \text{ V}; V_{GS} = 0 \text{ V}$	$T_{VJ} = 25^{\circ}C$		2	100	μΑ
I <sub>GSS</sub>	gate source leakage current	$V_{DS} = 0 \text{ V}; V_{GS} = 20 \text{ V}$	$T_{VJ} = 25^{\circ}C$			0.6	μΑ
$R_{G}$	internal gate resistance					1.1	Ω
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	input capacitance output capacitance reverse transfer (Miller) capacitance	V <sub>DS</sub> = 1000 V; V <sub>GS</sub> = 0 V; f = 1 MHz	T <sub>vJ</sub> = 25°C		2790 220 15		pF pF pF
$egin{array}{c} oldsymbol{Q}_{g} \ oldsymbol{Q}_{gs} \ oldsymbol{Q}_{gd} \end{array}$	total gate charge gate source charge gate drain (Miller) charge	$V_{DS} = 800 \text{ V}; I_{D} = 50 \text{ A}; V_{GS} = -5/20 \text{ V}$	/ T <sub>VJ</sub> = 25°C		160 46 50		nC nC nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> E <sub>on</sub> E <sub>off</sub> E <sub>rec(off)</sub>	turn-on delay time current rise time turn-off delay time current fall time turn-on energy per pulse turn-off energy per pulse reverse recovery losses at turn-off	Inductive switching $\begin{array}{l} \text{Inductive switching} \\ \text{V}_{DS} = 800 \text{ V}; \text{I}_{D} = 50 \text{ A} \\ \text{V}_{GS} = -5/20 \text{ V}; \text{R}_{G} = 2 \Omega \text{ (external)} \end{array}$	T <sub>VJ</sub> = 25°C				ns ns ns ns mJ mJ
$R_{thJC}$	thermal resistance junction to case thermal resistance junction to heatsink	with heatsink compound; IXYS test	setup 1)		0.38	0.27	K/W K/W

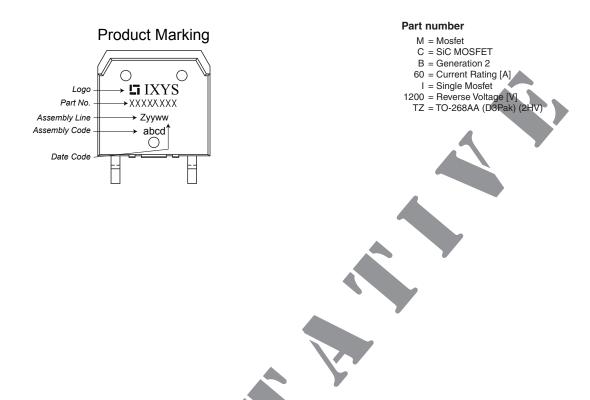
<sup>1)</sup> part is mounted directly on heat sink

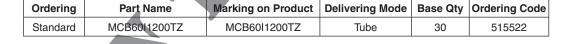
Source-Drain Diode				Ratings			
Symbol	<b>Definitions</b> Conditions		min.	typ.	max.		
I <sub>S25</sub>	continuous source current $V_{GS} = -5 \text{ V}$	$T_{C} = 25^{\circ}C$ $T_{C} = 80^{\circ}C$				A A	
V <sub>SD</sub>	forward voltage drop $I_F = 25 \text{ A}; V_{GS} = -5 \text{ V}$	$T_{VJ} = 25^{\circ}C$ $T_{VJ} = 175^{\circ}C$		4.0 3.5		V	
t <sub>rr</sub> Q <sub>RM</sub> I <sub>RM</sub>	reverse recovery time reverse recovery charge (intrinsic diode) $ V_{GS} = -5 \text{ V}; I_F = 50 \text{ A} $ $V_R = 800 \text{ V}; -di_F/dt = 1000 \text{ A/}\mu\text{s} $	$T_{VJ} = 25^{\circ}C$		45 410 13.5		ns nC A	





Package	TO-268AA (D3Pak-HV)						
				Ratings			
Symbol	Definitions Conditio	ns		min.	typ.	max.	Unit
I <sub>RMS</sub>	RMS current per termi	nal					Α
T <sub>stg</sub>	storage temperature			-40		150	°C
T <sub>op</sub>	operation temperature			-40		150	°C
T <sub>VJ</sub>	virtual junction temperature			-40		175	°C
Weight					4		g
F <sub>c</sub>	mounting fource with clip			20		120	Nm
d <sub>Spp/App</sub> d <sub>Spb/Apb</sub>	creepage distance on surface   striking distance through air	terminal to terminal	9.4			mm	
		ougn air	terminal to backside	5.6			mm

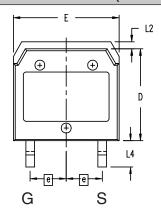


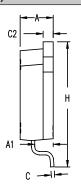


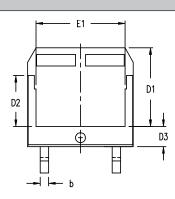


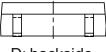


### Outlines TO-268AA (D3Pak-HV)

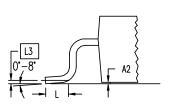


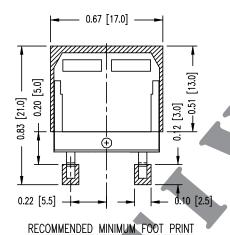






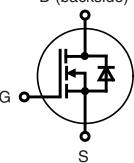
D; backside





Millimeter min max min max Α 4.90 5.10 0.193 0.201 Α1 2.70 2.90 0.106 0.114 A2 0.02 0.001 0.010 0.25 1.15 1.45 0.045 0.057 С 0.40 0.65 0.016 0.026 C2 1.60 0.057 0.063 14.00 D 13.80 0.543 0.551 D1 11.80 12.10 0.465 0.476 D2 7.50 7.80 0.295 0.307 D3 2.90 3.20 0.114 0.126 Ε 15.85 0.624 0.632 16.05 13.30 13.60 0.524 0.535 5.450 BSC 0.215 BSC 18.70 19.10 0.736 0.752 2.00 1.70 0.067 0.079 1.00 1.15 0.039 0.045 0.250 BSC 0.010 BSC 3.80 4.10 0.150 0.161





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